

Surface Mount ^{top hat} Directional Coupler

DBTC16-282LX+

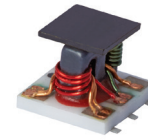
50Ω, 16dB coupling, 5 to 2850 MHz

Features

- very flat coupling
- very broadband, multi octave
- temperature stable, LTCC base
- all welded construction
- leads attached for better solderability
- micro miniature coupler
- aqueous washable
- protected by US Patents 6,140,887 & 6,784,521

Applications

- cellular
- PCS
- DECT/PHS
- GSM
- PCN
- GPS



Generic photo used for illustration purposes only

CASE STYLE: AT1642

+RoHS Compliant

The +Suffix identifies RoHS Compliance. See our web site for RoHS Compliance methodologies and qualifications

Available Tape and Reel at no extra cost	
Reel Size	Devices/Reel
7"	20, 50, 100, 200, 500
13"	1000, 2000

Electrical Specifications at 25°C

Parameter	Frequency (MHz)	Min.	Typ.	Max.	Unit
Frequency Range		5		2850	MHz
Mainline Loss	5-50	—	0.8	1.2	dB
	50-1000	—	0.8	1.10	
	1000-2850	—	1.8	2.4	
Nominal Coupling	5-2850	—	16.8	—	dB
Coupling Flatness(±)	5-1000	—	0.3	0.6	dB
	1000-2850	—	0.6	0.9	
Directivity	5-50	13	15	—	dB
	50-1000	15	18	—	
	1000-2850	6	15	—	
Return Loss (Input)	5-50	18	20	—	dB
	50-1000	18	22	—	
	1000-2850	15	18	—	
Return Loss (Output)	5-50	18	22	—	dB
	50-1000	16	24	—	
	1000-2850	14	18	—	
Return Loss (Coupled)	5-50	13	15	—	dB
	50-1000	14	18	—	
	1000-2850	7	10	—	
Input Power	5-100	—	—	0.5	W
	100-2850	—	—	1.0	

Maximum Ratings

Parameter	Ratings
Operating Temperature	-40°C to 85°C
Storage Temperature	-55°C to 100°C

Permanent damage may occur if any of these limits are exceeded.

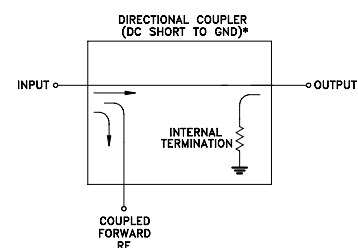
Pin Connections

Function	Pad Number
INPUT	3
OUTPUT	4
COUPLED	1
GROUND	2
ISOLATE (DO NOT USE)	6

Product Marking



Electrical Schematic



* ELECTRICAL SCHEMATIC IS FOR DIRECTIONAL COUPLER WITH INTERNAL TRANSFORMER(S) THAT ROUTES DC FROM RF PORTS TO GROUND.

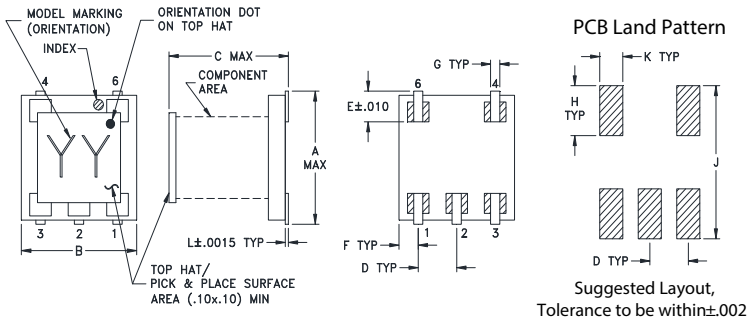
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M167093
DBTC16-282LX+
WP/CP/AM
180517
Page 1 of 2

DBTC16-282LX+

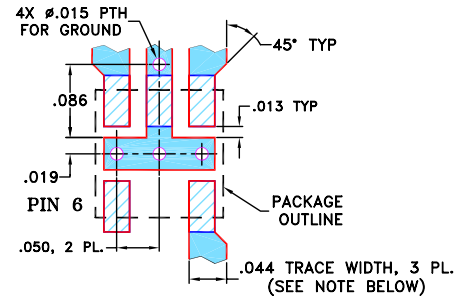
Outline Drawing



Outline Dimensions (inch/mm)

A	B	C	D	E	F
.166	.150	.155	.050	.037	.025
4.22	3.81	3.94	1.27	0.94	0.64
G	H	J	K	L	wt
.012	.060	.184	.030	.004	grams
0.30	1.52	4.67	0.76	0.10	0.10

Demo Board MCL P/N: TB-278 Suggested PCB Layout (PL-150)

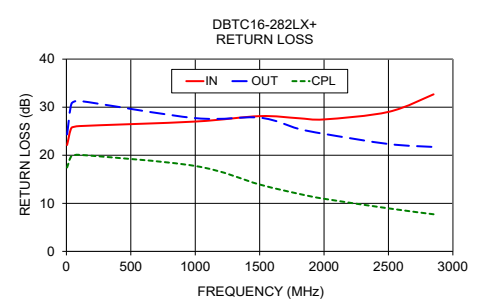
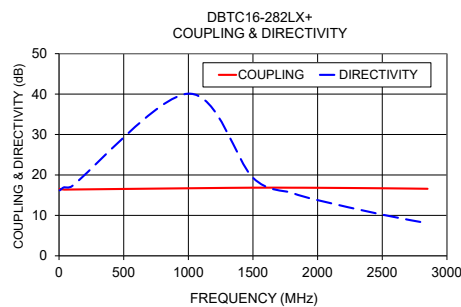
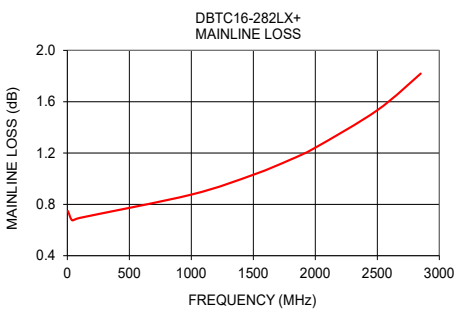


- NOTES: 1. TRACE WIDTH IS SHOWN FOR ROGERS R04350B WITH DIELECTRIC THICKNESS $0.020" \pm 0.0015"$; COPPER: 1/2 OZ. EACH SIDE. FOR OTHER MATERIALS TRACE WIDTH MAY NEED TO BE MODIFIED.
2. BOTTOM SIDE OF THE PCB IS CONTINUOUS GROUND PLANE.

- DENOTES PCB COPPER LAYOUT WITH SMOBC (SOLDER MASK OVER BARE COPPER)
- DENOTES COPPER LAND PATTERN FREE OF SOLDER MASK

Typical Performance Data

Frequency (MHz)	Mainline Loss (dB) In-Out	Coupling (dB) In-Cpl	Directivity (dB)	Return Loss (dB)		
				In	Out	Cpl
5	0.75	16.56	16.18	22.13	24.33	17.45
40	0.68	16.38	16.96	25.73	30.78	19.85
100	0.69	16.40	17.23	26.07	31.31	20.09
1000	0.88	16.71	40.10	27.01	27.73	17.77
1500	1.03	16.85	19.30	28.14	27.82	13.91
1800	1.15	16.85	15.58	27.71	25.52	12.00
2000	1.24	16.83	13.77	27.46	24.45	10.95
2500	1.53	16.71	10.18	29.02	22.34	8.95
2850	1.82	16.58	8.06	32.68	21.73	7.72



Additional Notes

- A. Performance and quality attributes and conditions not expressly stated in this specification document are intended to be excluded and do not form a part of this specification document.
- B. Electrical specifications and performance data contained in this specification document are based on Mini-Circuits' applicable established test performance criteria and measurement instructions.
- C. The parts covered by this specification document are subject to Mini-Circuits standard limited warranty and terms and conditions (collectively, "Standard Terms"); Purchasers of this part are entitled to the rights and benefits contained therein. For a full statement of the Standard Terms and the exclusive rights and remedies thereunder, please visit Mini-Circuits' website at www.minicircuits.com/MCLStore/terms.jsp



Directional Coupler

DBTC16-282LX+

Typical Performance Data

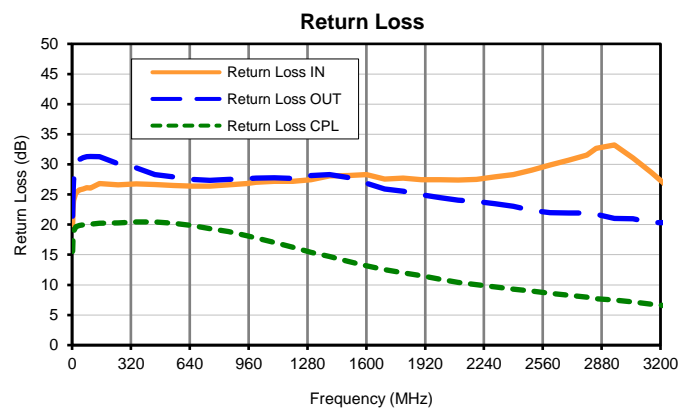
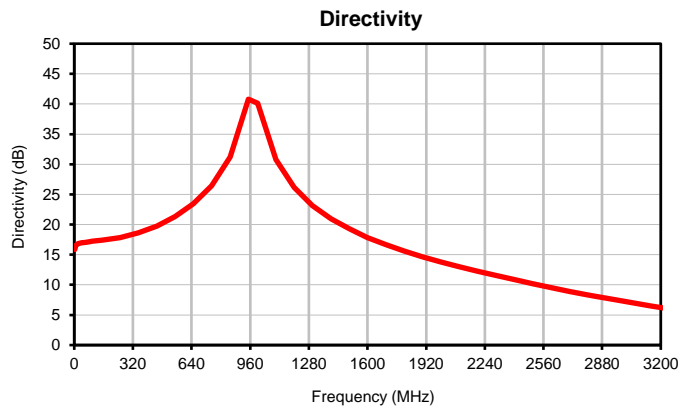
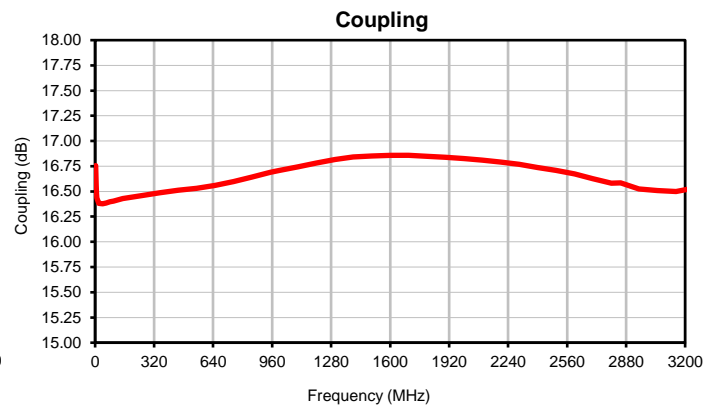
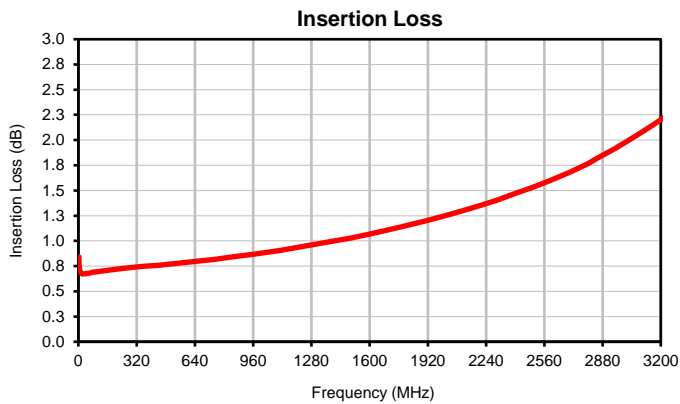
FREQUENCY (MHz)	INSERTION LOSS (dB)	COUPLING (dB)	DIRECTIVITY (dB)	RETURN LOSS (dB)		
				IN	OUT	CPL
3	0.84	16.76	15.87	19.95	21.39	15.56
5	0.75	16.56	16.18	22.13	24.33	17.45
7	0.71	16.48	16.38	23.29	26.14	18.37
9	0.69	16.43	16.55	23.98	27.40	18.87
20	0.67	16.38	16.83	25.25	29.92	19.65
40	0.68	16.38	16.96	25.73	30.78	19.85
60	0.68	16.39	17.05	25.92	31.10	19.96
80	0.69	16.40	17.14	26.13	31.28	20.03
100	0.69	16.40	17.23	26.07	31.31	20.09
150	0.71	16.43	17.42	26.80	31.29	20.22
250	0.73	16.46	17.81	26.60	30.12	20.31
350	0.75	16.49	18.62	26.77	29.40	20.44
450	0.76	16.51	19.72	26.64	28.28	20.43
550	0.78	16.53	21.31	26.51	27.91	20.22
650	0.80	16.56	23.46	26.41	27.50	19.86
750	0.82	16.60	26.43	26.37	27.36	19.33
850	0.84	16.64	31.18	26.63	27.53	18.83
950	0.86	16.69	40.79	26.79	27.62	18.18
1000	0.88	16.71	40.10	27.01	27.73	17.77
1100	0.90	16.74	30.79	27.20	27.79	17.06
1200	0.93	16.78	26.16	27.18	27.65	16.25
1300	0.97	16.82	23.13	27.44	28.12	15.40
1400	1.00	16.84	20.96	28.09	28.29	14.70
1500	1.03	16.85	19.30	28.14	27.82	13.91
1600	1.07	16.86	17.84	28.32	26.85	13.15
1700	1.11	16.86	16.63	27.58	25.94	12.54
1800	1.15	16.85	15.58	27.71	25.52	12.00
1900	1.19	16.84	14.62	27.45	24.95	11.52
2000	1.24	16.83	13.77	27.46	24.45	10.95
2100	1.29	16.81	13.00	27.42	24.06	10.40
2200	1.35	16.79	12.27	27.52	23.86	10.03
2300	1.41	16.77	11.59	27.95	23.45	9.69
2400	1.47	16.74	10.87	28.30	23.03	9.32
2500	1.53	16.71	10.18	29.02	22.34	8.95
2600	1.60	16.68	9.54	29.90	21.99	8.60
2700	1.68	16.63	8.92	30.72	21.92	8.31
2800	1.77	16.58	8.33	31.57	21.95	7.98
2850	1.82	16.58	8.06	32.68	21.73	7.72
2950	1.92	16.52	7.53	33.22	21.02	7.48
3050	2.03	16.51	7.00	31.05	20.96	7.17
3150	2.14	16.50	6.49	28.69	20.36	6.81
3250	2.26	16.54	5.99	25.99	20.33	6.46



Directional Coupler

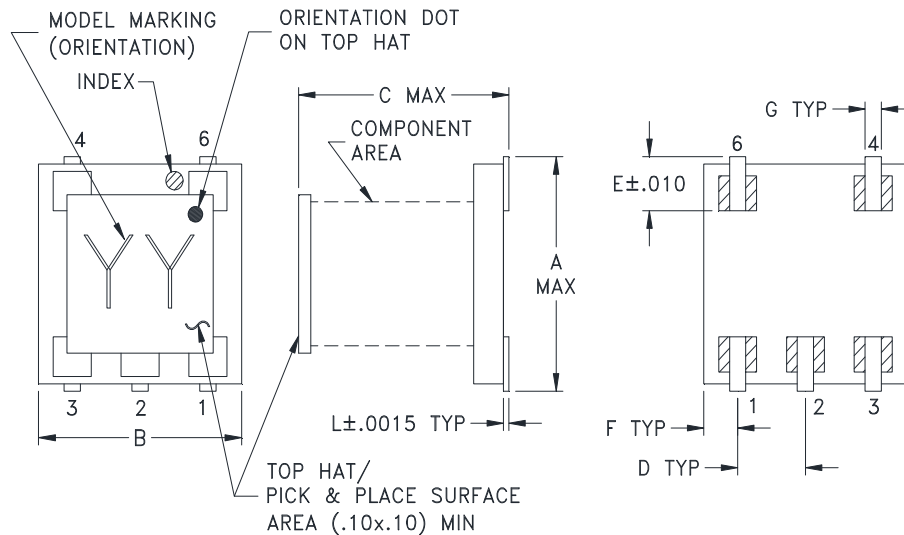
Typical Performance Curves

DBTC16-282LX+



Outline Dimensions

AT1642



PCB Land Pattern

Suggested Layout,
Tolerance to be within ±.002

CASE #	A	B	C	D	E	F	G	H	J	K	L	WT. GRAMS
AT1642	.166 (4.22)	.150 (3.81)	.155 (3.94)	.050 (1.27)	.037 (0.94)	.025 (.64)	.012 (.30)	.060 (1.52)	.184 (4.67)	.030 (.76)	.004 (0.10)	.10

Dimensions are in inches (mm). Tolerances: 2 Pl. ± .01; 3 Pl. ± .005

Notes:

1. Open style, ceramic base.
2. Termination finish:
For RoHS Case Styles: Tin plate.
3. Top-hat total thickness: .013 inches MAX.
4. Orientation Dot on Top Hat & Marking on the Substrate both refers to Pin #6 of the Unit.



P.O. Box 350186, Brooklyn, New York 11235-0003 (718) 934-4500 Fax (718) 332-4661 For detailed performance specs & shopping online see Mini-Circuits web site

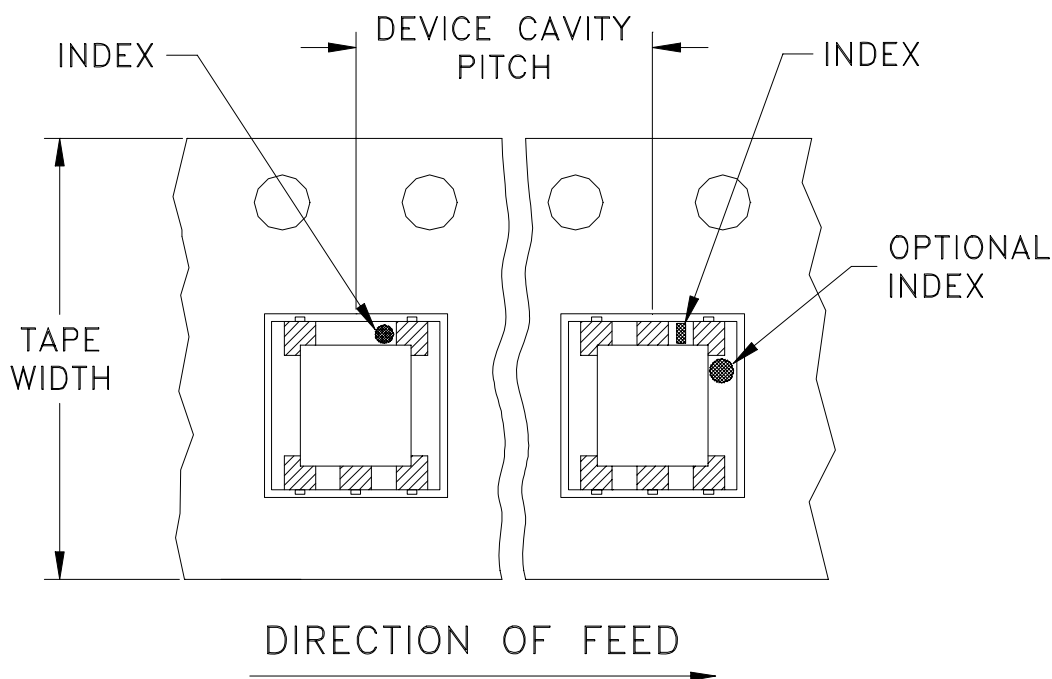


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RF/IF MICROWAVE COMPONENTS

Tape & Reel Packaging TR-F76

DEVICE ORIENTATION IN T&R



Tape Width, mm	Device Cavity Pitch, mm	Reel Size, inches	Devices per Reel
12	8	7	20
			50
			100
			200
			500
		13	1000
			2000

Note: Please consult individual model data sheet to determine device per reel availability.

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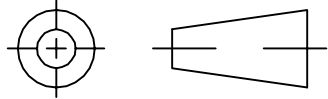
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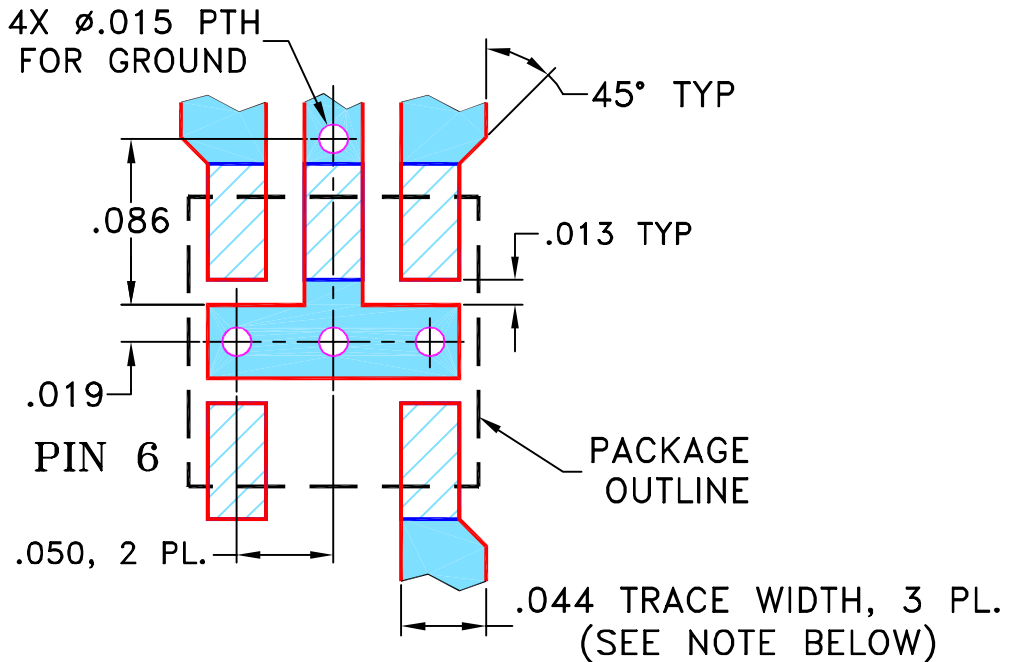
THIRD ANGLE PROJECTION



REVISIONS

REV	ECN No.	DESCRIPTION	DATE	DR	AUTH
OR	M90454	NEW RELEASE	01/16/04	AV	WP
A	M93049	AT1030 WAS AT1029	07/02/04	MMG	WP
B	M102713	ADDED "...WITH SMOBC"	01/17/06	MMG	IL

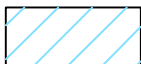
SUGGESTED MOUNTING CONFIGURATION FOR AT1030 CASE STYLE, "na" PIN CONNECTION



- NOTES: 1. TRACE WIDTH IS SHOWN FOR ROGERS RO4350B WITH DIELECTRIC THICKNESS 0.020" ± 0.0015"; COPPER: 1/2 OZ. EACH SIDE. FOR OTHER MATERIALS TRACE WIDTH MAY NEED TO BE MODIFIED.
 2. BOTTOM SIDE OF THE PCB IS CONTINUOUS GROUND PLANE.



DENOTES PCB COPPER LAYOUT WITH SMOBC (SOLDER MASK OVER BARE COPPER)



DENOTES COPPER LAND PATTERN FREE OF SOLDER MASK

UNLESS OTHERWISE SPECIFIED

INITIALS

DATE

DIMENSIONS ARE IN INCHES

DRAWN

AV

01/08/04

TOLERANCES ON:

CHECKED

IL

01/16/04

2 PL DECIMALS ±

APPROVED

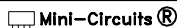
WP

01/16/04

3 PL DECIMALS ± .005

ANGLES ±

FRACTIONS ±



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Brooklyn NY 11235

PL, na, AT1030, DBTC, TB-278

SIZE

CODE IDENT

DRAWING NO:

REV:

A

15542

98-PL-150

B

FILE:

98PL150

SCALE:

10:1

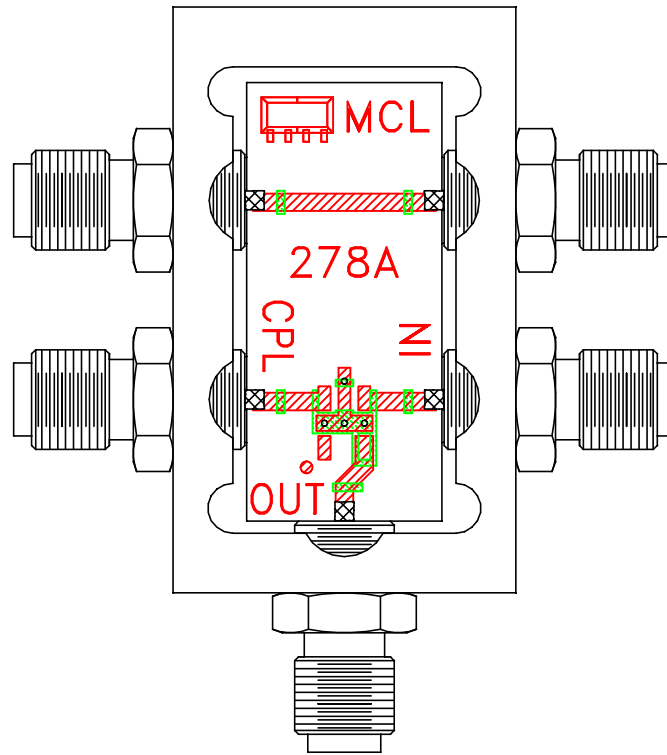
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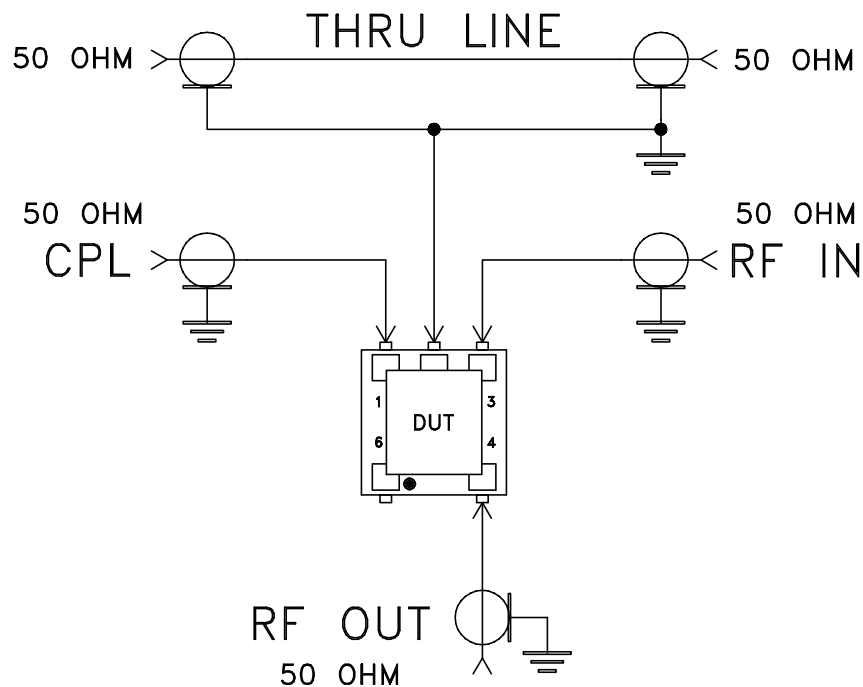
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ASHEETA1.DWG REV:A DATE:01/12/95

Evaluation Board and Circuit




TB-278



Schematic Diagram

Notes:

1. 50 Ohm SMA Female connectors.
2. PCB Material: Rogers R04350B or its equivalent, Dielectric Constant=3.5, Thickness=.020"

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All Mini-Circuits products are manufactured under exacting quality assurance and control standards, and are capable of meeting published specifications after being subjected to any or all of the following physical and environmental test.

Specification	Test/Inspection Condition	Reference/Spec
Operating Temperature	-40° to 85°C Ambient Environment	Individual Model Data Sheet
Storage Temperature	-55° to 100° C Ambient Environment	Individual Model Data Sheet
Humidity	90 to 95% RH, 240 hours, 50°C	MIL-STD-202, Method 103, Condition A, Except 50°C and end-point electrical test done within 12 hours
Thermal Shock	-55° to 100°C, 100 cycles	MIL-STD-202, Method 107, Condition A-3, except +100°C
Solder Reflow Heat	Sn-Pb Eutetic Process: 225°C peak Pb-Free Process 245° - 250°C peak	J-STD-020, Table 4-1, 4-2 and 5-2, Figure 5-1
Solderability	10X Magnification	J-STD-002, 95% Coverage
Vibration (High Frequency)	20g peak, 10-2000 Hz, 12 times in each of three perpendicular directions (total 36)	MIL-STD-202, Method 204, Condition D
Mechanical Shock	50g, 11 ms, 1/2-sine, 18 shocks: 3 each direction, each of 3 axes	MIL-STD-202, Method 213, Condition A
Marking Resistance to Solvents	Isopropyl alcohol + mineral spirits at 25°C; terpene defluxer at 25°C; distilled water + proylene glycol monomethyl ether + monoethanolamine at 63°C to 70°C	MIL-STD-202, Method 215